MA26V03

Silicon epitaxial planar type

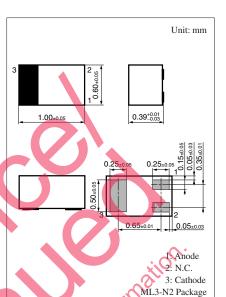
For VCO

Features

- \bullet Good linearity and large capacitance-ratio in C_D V_R relation
- \bullet Small series resistance $r_{\rm D}$
- High frequency type by this low capacitance

Absolute Maximum Ratings $T_a = 25^{\circ}C$

Parameter	Symbol	Rating	Unit	
Reverse voltage	V _R	6	V	
Junction temperature	Tj	125	°C	
Storage temperature	T _{stg}	-55 to +125	°C	



Marking Symbol: 2F

Electrical Characteristics $T_a = 25^{\circ}C \pm 3^{\circ}C$

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Parameter	Symbol	Conditions	Min	Тур	Max	Unit		
Reverse current	I _R	$V_R = 5 V$			10	nA		
Diode capacitance	C _{DIV}	$V_R = 1 V, f = 1 MHz$	5.20		5.80	pF		
	C _{D4V}	$V_R = 4$ V, $f = 1$ MHz	2.10		2.58			
Capacitance ratio	C_{D1V}/C_{D4V}		2.1		2.6			
Series resistance *	r _D	$V_{R} = 4$ V, f = 470 MHz			0.3	Ω		

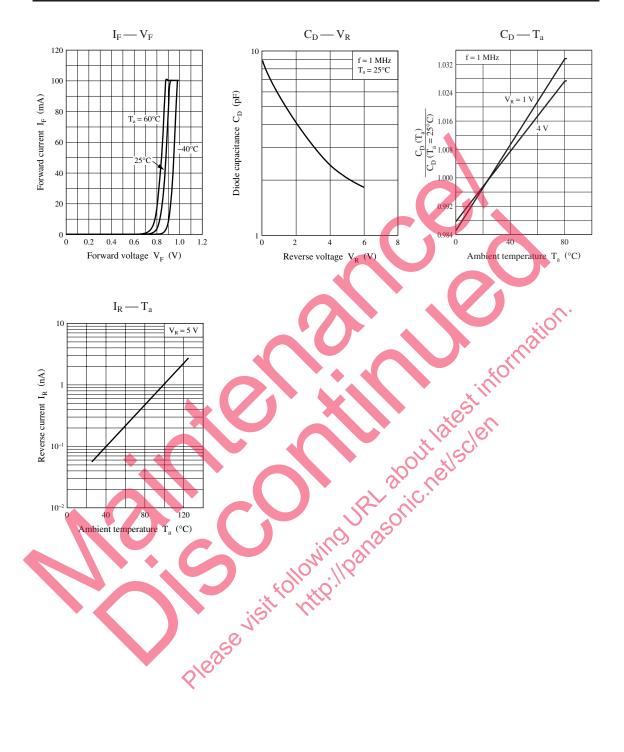
Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7031 measuring methods for diodes.

2. Absolute frequency of input and output is 470 MHz.

3. *: Measuring instrument: YHP MODEL 4191A RF IMPEDANCE ANALYZER

MA26V03





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